

	L #	Hits	Search Text	DBs	Time Stamp
1	L1	24	("20030026989"   "20030059633"   "5562998"   "5855753"   "5998003"   "6103386"   "6203613"   "6203927"   "6416870"   "6492038"   "6503330"   "6585823") .PN. from IDS (1/16/04)	US - PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 13:53
2	L2	20562	(427/566, 567, 569-577, 595, 596, 597, 248.1-255.7) .CCLS.	US - PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:00
3	L3	4263	(427/567, 570, 576, 585, 597, 249.15, 249.17, 255.29, 255.31, 255.32, 255.394) .CCLS.	US - PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:00
4	L4	21217	(427/566, 567, 569-577, 585, 595, 596, 597, 248.1-255.7) .CCLS.	US - PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:01
5	L5	68409	(ALD (atomic Mono) near (layer deposit deposition) monolayer atomiclayer)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:04
6	L6	1903	((Tantalum Ta) adj (oxide pentoxide) Ta2O5 "Ta.sub.20.sub.5" "Ta.sub.20.sub.5") with (grain crystal\$7 column columnar orient\$7)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:07
7	L7	3980	((Tantalum Ta) adj (oxide pentoxide) Ta2O5 "Ta.sub.20.sub.5" "Ta.sub.20.sub.5") same (grain crystal\$7 column columnar orient\$7)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:08

10/15/08/10

	L #	Hits	Search Text	DBs	Time Stamp
8	L8	16	((Tantalum Ta) adj (oxide pentoxide) Ta205 "Ta.sub.20.sub.5" "Ta.sub.2 O.sub.5") with (grain crystal\$7) near5 (column columnar)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:09
9	L9	2455937	(Silicon Si siliconnitrite siliconcarbide "SiN.m/c." SiC Si3N4 "Si.sub.x C" "Si.sub.3N.sub.4" "Si.sub.3 N.sub.4" "Si.sub.xN.sub.y" "Si.sub.x N.sub.y")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:16
10	L10	5	L9 same L8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:14
	L10 not L16		46u3 L31		
11	L11	1604	L9 same L7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:14
12	L12	652	L9 same L6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:15
13	L13	2204	L5 same ((Silicon Si) adj (carbide nitride) siliconnitrite siliconcarbide "SiN.m/c." SiC Si3N4 "Si.sub.x C" "Si.sub.3N.sub.4" "Si.sub.3 N.sub.4" "Si.sub.xN.sub.y" "Si.sub.x N.sub.y" oxycarbide carbonitride)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:16
14	L14	3392	L5 same (alumina hafnia (aluminum Al hafnium Hf) adj (oxide dioxide) Al2O3 HfO2 "Al.sub.20.sub.3" "HfO.sub.2" "Al.sub.2 O.sub.3")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:20

	L #	Hits	Search Text	DBs	Time Stamp
15	L15	0	L10 same (L13 or L14)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:22
16	L16	1	L10 and (L13 or L14) <i>thus is pre-pub 2005/0158570A1</i>	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:21
17	L17	0	L8 and (L13 or L14) not L16	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:21
18	L18	5	L12 same (L13 or L14) not L16	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:22
19	L19	32	L12 and (L13 or L14) not (L16 or L18)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:23
20	L20	17	L11 same (L13 or L14) not (L16 or L18 or L19)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:23
21	L21	53	L11 and (L13 or L14) not (L16 or L18 or L19 or L20)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:25

L29

	L #	Hits	Search Text	DBs	Time Stamp
22	L22	1	L8 and L5 and L4	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:25
23	L23	0	L8 and L5 and L4 not L16	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:26
24	L24	1	L8 and L4 not L16	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:26
25	L25	14	L8 not (L16 or L24)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:28
26	L26	0	L19 and L4	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:28
27	L27	0	L20 and L4	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:28
28	L28	2	L21 and L4	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:28

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	L #	Hits	Search Text	DBs	Time Stamp
29	L29	51	L21 not L28	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:29
30	L30	14	(("5100847") or ("6159553") or ("6582779") or ("6350404") or ("6699604") or ("6861164") or ("6887594")).PN.  from inventor name search	US - PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 14:38

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	L #	Hits	Search Text	DBs	Time Stamp
29	L19	32	L12 and (L13 or L14) not (L16 or L18)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 16:07
30	L20	17	L11 same (L13 or L14) not (L16 or L18 or L19)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 17:17
31	L29	51	L21 not L28	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 18:48
32	L32	70	L7 same (EBPDV EB (E electron) adj beam)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 18:51
33	L33	32	L32 and (L11 or L12)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 18:51
34	L34	30	L33 not (L16 or L18 or L19 or L20 or L28 or L29)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/06/17 18:53

Day : Saturday  
Date: 6/17/2006

Time: 14:33:29

**PALM INTRANET****Inventor Name Search Result**

Your Search was:

Last Name = LI

First Name = CHIEN-WEI

Application#	Patent#	Status	Date Filed	Title	Inventor Name
<u>07297530</u>	Not Issued	161	01/17/1989	SUPER TOUGH MONOLITHIC SILICON NITRIDE DESCRIPTION OF THE INVENTION	LI, CHIEN-WEI
<u>07450899</u>	Not Issued	161	12/14/1989	SUPER TOUGH MONOLITHIC SILICON NITRIDE	LI, CHIEN-WEI
<u>07576330</u>	Not Issued	166	08/31/1990	SUPER TOUCH MONOLITHIC SILICON NITRIDE	LI, CHIEN-WEI
<u>07716142</u>	Not Issued	166	06/17/1991	HIGH TOUGHNESS-HIGH STRENGTH SINTERED SILICON NITRIDE	LI, CHIEN-WEI
<u>07759970</u>	<u>5100847</u>	150	09/17/1991	SUPER TOUGH MONOLITHIC SILICON NITRIDE	LI, CHIEN-WEI
<u>07860958</u>	Not Issued	166	03/31/1992	MONOLITHIC SILICON NITRIDE HAVING HIGH FRACTURE TOUGHNESS	LI, CHIEN-WEI
<u>07865581</u>	Not Issued	166	04/09/1992	SINTERED SILICON NITRIDE OF HIGH TOUGHNESS, STRENGTH AND RELIABILITY	LI, CHIEN-WEI
<u>08075930</u>	Not Issued	161	06/14/1993	MONOLITHIC SILICON NITRIDE HAVING HIGH FRACTURE TOUGHNESS	LI, CHIEN-WEI
<u>08076940</u>	<u>5312788</u>	150	06/16/1993	HIGH TOUGHNESS, HIGH STRENGTH SINTERED SILICON NITRIDE	LI, CHIEN-WEI
<u>08096203</u>	<u>5637540</u>	150	07/23/1993	SINTERED SILICON NITRIDE OF HIGH TOUGHNESS, STRENGTH AND RELIABILITY	LI, CHIEN-WEI
<u>08168439</u>	<u>5449649</u>	150	12/17/1993	MONOLITHIC SILICON NITRIDE HAVING HIGH FRACTURE TOUGHNESS	LI, CHIEN-WEI

08257598	5494866	150	06/09/1994	STRESS-RUPTURE RESISTANT SINTERED SILICON NITRIDE	LI, CHIEN-WEI
08789699	5759933	150	01/27/1997	GAS PRESSURE SINTERED SILICON NITRIDE HAVING HIGH STRENGTH AND STRESS RUPTURE RESISTANCE	LI, CHIEN-WEI
09208109	6159553	150	11/27/1998	THERMAL BARRIER COATING FOR SILICON NITRIDE	LI, CHIEN-WEI
09371826	6582779	150	08/11/1999	SILICON NITRIDE COMPONENTS WITH PROTECTIVE COATING	LI, CHIEN-WEI
09592320	6350404	150	06/13/2000 ?	Method for producing a ceramic part with an internal structure	LI, CHIEN-WEI
09595791	6415376	150	06/16/2000 ?	APPARATUS AND METHOD FOR ISSUE GROUPING OF INSTRUCTIONS IN A VLIW PROCESSOR	LI, CHIEN-WEI
09598015	6699604	150	06/20/2000 ?	PROTECTIVE COATING INCLUDING POROUS SILICON NITRIDE MATRIX AND NOBLE METAL	LI, CHIEN-WEI
09990640	6861164	150	11/21/2001	ENVIRONMENTAL AND THERMAL BARRIER COATING FOR CERAMIC COMPONENTS	LI, CHIEN-WEI
10085437	6684320	150	02/28/2002 ?	APPARATUS AND METHOD FOR ISSUE GROUPING OF INSTRUCTIONS IN A VLIW PROCESSOR	LI, CHIEN-WEI
10085724	Not Issued	93	02/28/2002 X	AREA AND POWER EFFICIENT VLIW PROCESSOR WITH IMPROVED SPEED	LI, CHIEN-WEI
10621168	6977233	150	07/15/2003 X	SINTERED SILICON NITRIDE	LI, CHIEN-WEI
10621719	Not Issued	161 abn	07/16/2003	Environmental & thermal barrier coating	LI, CHIEN-WEI
10644523	Not Issued	71	08/18/2003	Diffusion barrier coating for silicon-based components	LI, CHIEN-WEI
10682752	Not Issued	93 abn	10/08/2003	BRAZE-BASED PROTECTIVE COATING FOR SILICON NITRIDE	LI, CHIEN-WEI
10719629	Not Issued	71	11/21/2003	Oxidation barrier coatings for silicon based ceramics	LI, CHIEN-WEI
10759810	Not Issued	71	01/16/2004	Atomic layer deposition for turbine components	LI, CHIEN-WEI

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34-51  
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<u>10773373</u>	<u>6887594</u>	150	02/05/2004	ENVIRONMENTAL AND THERMAL BARRIER COATING FOR CERAMIC COMPONENTS	LI, CHIEN-WEI
<u>10982445</u>	Not Issued	30	11/05/2004	Protective coating for ceramic components	LI, CHIEN-WEI
<u>11127522</u>	Not Issued	30	05/10/2005	Ternary carbide and nitride materials having tribological applications and methods of making same	LI, CHIEN-WEI
<u>11127524</u>	Not Issued	30	05/10/2005	Ternary carbide and nitride composites having tribological applications and methods of making same	LI, CHIEN-WEI
<u>11216877</u>	Not Issued	30	08/30/2005	Sintered silicon nitride	LI, CHIEN-WEI
<u>60278102</u>	Not Issued	159	03/23/2001	Environmental and thermal barrier coating for ceramic components	LI, CHIEN-WEI
<u>60575040</u>	Not Issued	159	05/26/2004	Ternary metal carbides-silver composite materials for tribological applications	LI, CHIEN-WEI
<u>60575041</u>	Not Issued	159	05/26/2004	Novel carbide materials for tribological applications	LI, CHIEN-WEI
<u>60740172</u>	Not Issued	20	11/28/2005	Ruthenium precursors and intermediates for deposition processes, their production and method of use	LI, CHIEN-WEI
<u>60740206</u>	Not Issued	20	11/28/2005	Ruthenium precursors and intermediates for plasma-enhanced ALD	LI, CHIEN-WEI

Inventor Search Completed: No Records to Display.

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Last Name

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LI

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